



Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	1/11

LED APPROVAL SHEET

Part No:

AS303GW-ZRM-700mA

NOTE :

Green Part

MAKER			CUSTOMER	
R&D	QA	Sales	Checked	Approved

Prepared	Checked	Approved
Rachel Lee	Sky Lin/Sniper Liu	Kenneth Wu

Description of P/N No.

AS303GW - ZRM - 700mA

↓
SOLIDLITE LED – AS303GW (55mil) Series

↓
660nm RED Series

↓
Test Condition

Description of Lot.

↓
Month

↓
NO.

Solidlite Corp.



P/N :

Lot :

Date: . Rank:

Q'ty : . QA

Description of Rank

↓
V_f Code

↓
I_e Code

↓
 λ_p Code



Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	3/11

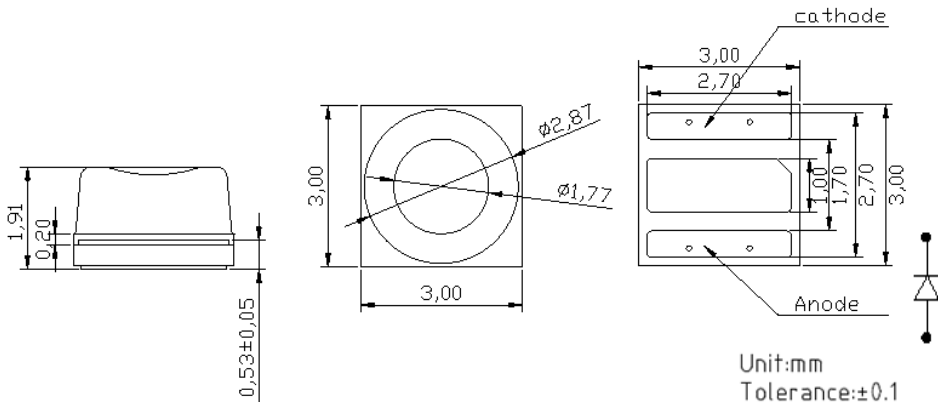
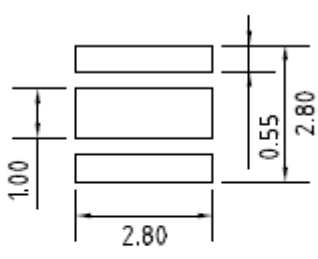
Absolute Maximum Ratings at $T_a=25^{\circ}\text{C}$

Parameter	MAX.	Unit
DC forward current	1	A
Power Dissipation	2.5	W
Reverse Voltage (V_r)	5	V
Operating Temperature Range	-40°C to $+85^{\circ}\text{C}$	
Storage Temperature Range	-55°C to $+125^{\circ}\text{C}$	
Lead Soldering Temperature	265°C for 10 seconds	

Electrical and Optical Characteristics at $T_a = 25^{\circ}\text{C}$

Parameter	Test Condition	Symbol	Min.	Typ.	Max.	Unit
Forward Voltage	$I_F=700\text{mA}$	V_f	1.9	—	2.5	V
Reverse Current	$V_R=-10\text{V}$	I_R	—	—	1	μA
Peak Wavelength	$I_F=700\text{mA}$	λ_P	655	—	670	nm
Spectral Bandwidth (FWHM)	$I_F=700\text{mA}$	$\Delta\lambda$	—	20	—	nm
Radiant Intensity	$I_F=700\text{mA}$	I_e	—	180	—	mW/sr
Total Radiant Flux	$I_F=700\text{mA}$	Φ_e	—	950	—	mW
Viewing Angle	—	$2\theta_{1/2}$	—	120	—	deg

Recommend forward current for longer duration is 700mA.
These values measured by Spectrum Analyzer of SOLIDLITE.

Package outline dimensions :	Recommended pad :
 <p>Unit:mm Tolerance:±0.1</p>	 <p>Unit:mm Tolerance:±0.1</p>

Surface Mounting Condition

In automatic mounting of the SMD LED on printed circuit boards, any bending , expanding and pulling forces or shock against the SMD LEDs shall be kept min. to prevent them from electrical failures and mechanical damages of the devices .

Soldering Reflow

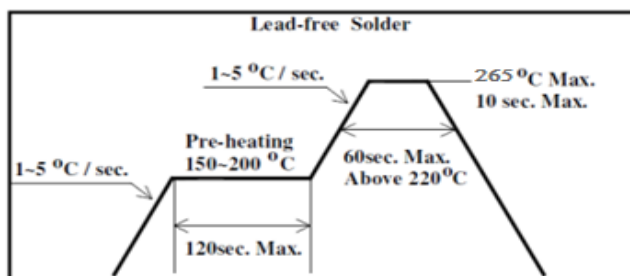
Soldering of the SMD LEDs shall conform to the soldering condition in the individual specifications. SMD LEDs are designed for Reflow Soldering.

In the reflow soldering , too high temperature and too large temperature gradient such as rapid heating / cooling may cause electrical & optical failure and damages of the devices .

Solidlite can not guarantee the LEDs after they have been assembled using the solder dipping method.

Recommended Soldering Temperature Time Profile (Reflow Soldering)

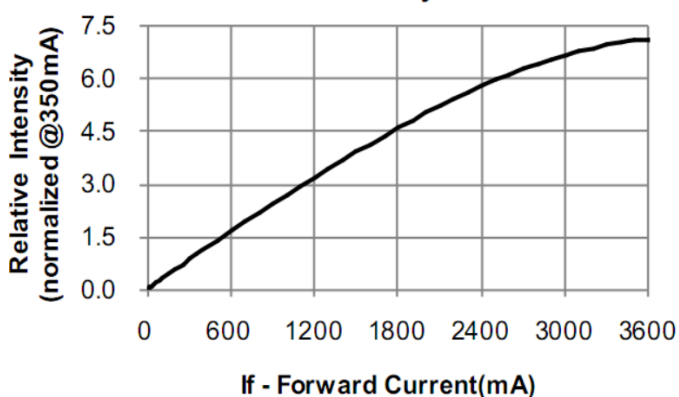
Lead Free Solder	
Pre-heat	150~200℃
Pre-heat time	120 sec. Max.
Peak-Temperature	265℃ Max.
Soldering time Condition	10 sec. Max.



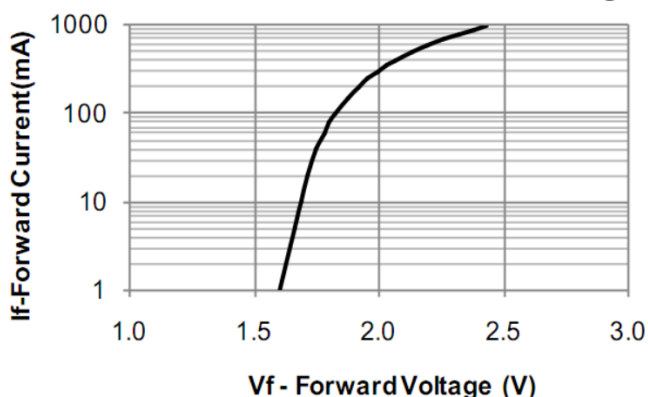
Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

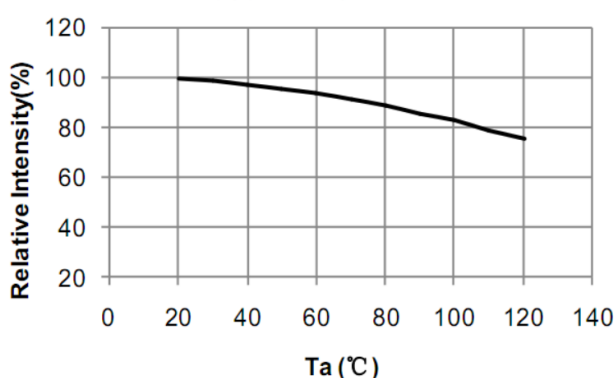
Relative Luminous Intensity vs. Forward Current



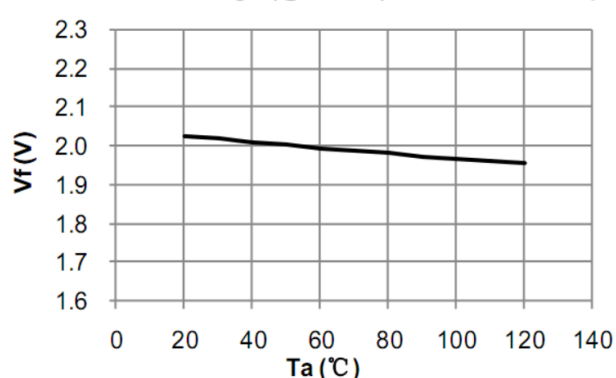
Forward Current vs. Forward Voltage



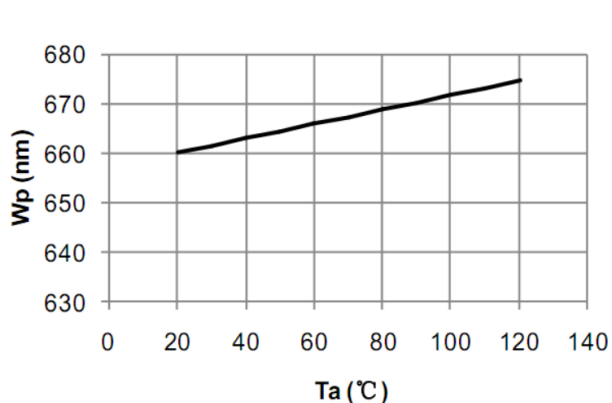
Relative Intensity(@350mA) vs. Ambient Temperature



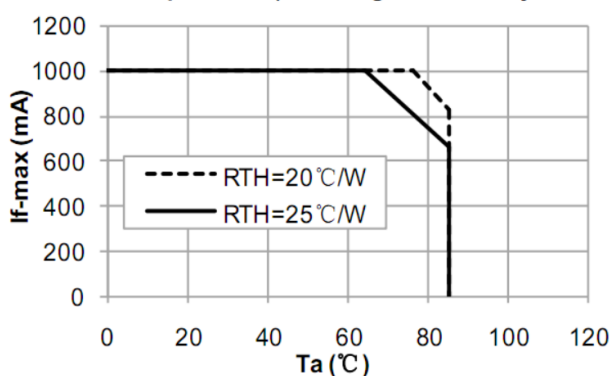
Forward Voltage (@350mA) vs. Ambient Temperature



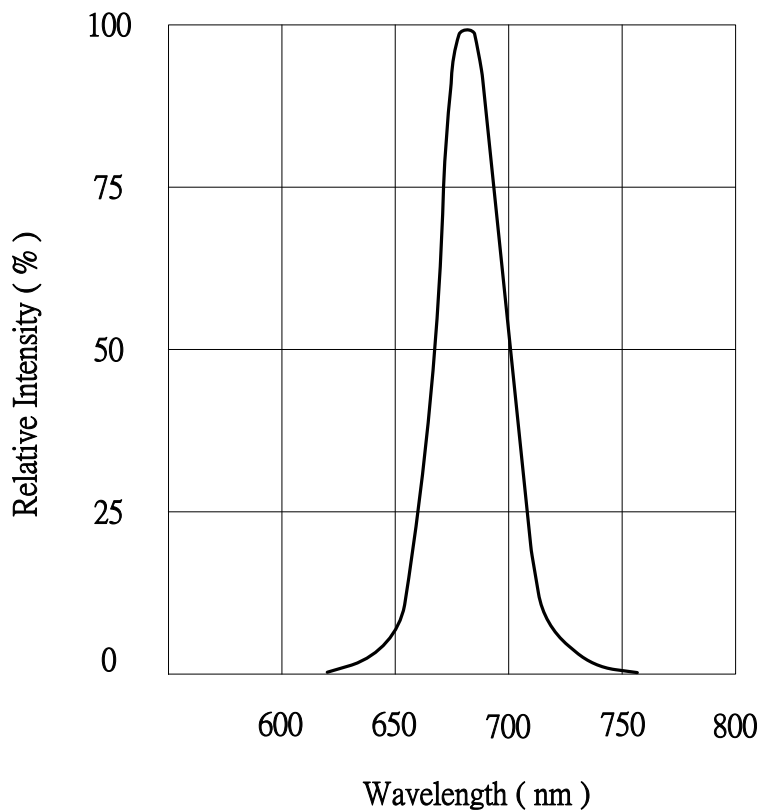
Peak Wavelength (@350mA) vs. Ambient Temperature



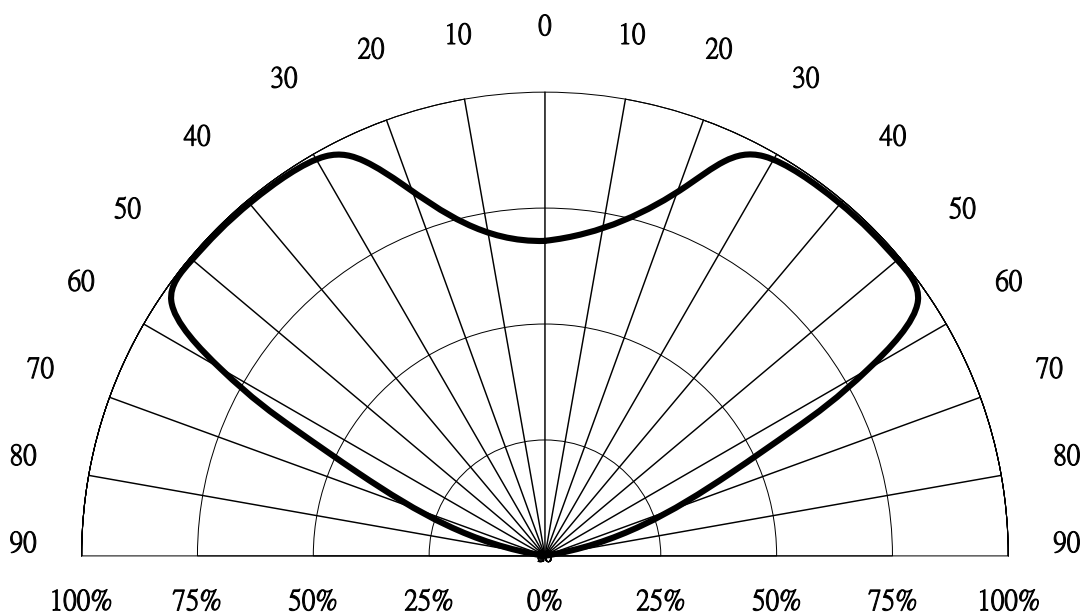
Maximum Driving Forward DC Current vs. Ambient Temperature (Derating based on Tjmax=125°C)



Relative Intensity vs Wavelength

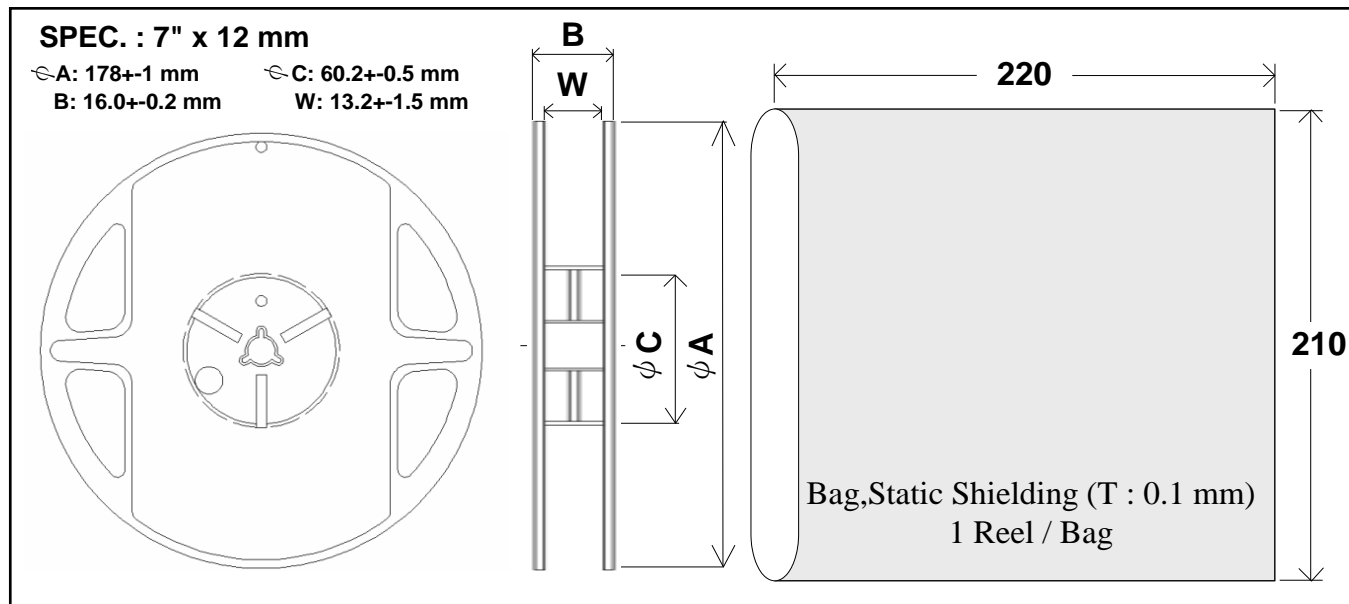


Spatial Distribution



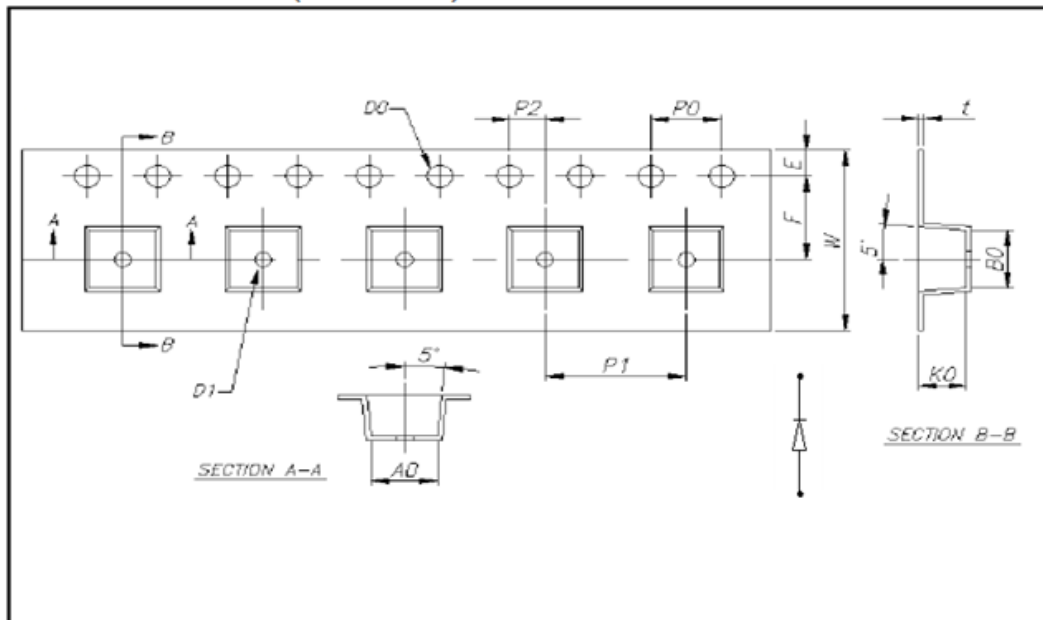
Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	7/11

Package Reel & Static Shielding Bag Dimensions :



Package Carrier Tape Dimensions : 500 pcs/Reel

Dimensions. (Unit: mm)



Item	Specification	Tol. (+/-)
W	12.00	\pm 0.20
E	1.75	\pm 0.10
F	5.50	\pm 0.10
D0	1.50	+0.10, -0
D1	1.00	\pm 0.10
P0	4.00	\pm 0.10
P1	8.00	\pm 0.10
P2	2.00	\pm 0.10
P0 x 10	40.00	\pm 0.20

t	0.25	\pm 0.05
A0	3.25	\pm 0.05
B0	3.25	\pm 0.05
K0	2.10	\pm 0.10



Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	8/11

Ranks Combination

Vf		A1	A2	A3
Vf@700mA	(V)	2.9~2.1	2.1~2.3	2.3~2.5

Radiant Intensity		BB	BC	BD	BE
Ie@700mA	(mcd)	10000~11000	11000~12000	12000~13000	13000~14000

Peak Wavelength		C1
λ_P @700mA	(nm)	655~670

The quantity ratio of the ranks is decided by SOLIDLITE.

Note:

- 1.The products are sensitive to static electricity and care must be fully taken when handling products.
- 2.Measurement Uncertainty of the Radiant Intensity: $\pm 10\%$
3. Measurement Uncertainty of the Peak Wavelength: $\pm 1\text{nm}$
4. Measurement Uncertainty of the Voltage: $\pm 0.05\text{V}$



Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	9/11

Cautions :

1. Storage

***Storage Conditions**

Before opening the package:

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package:

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 72 hours (3days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It's also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

*If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition.

Baking treatment: more than 24 hours at 65+/-5°C.

*Solidlite LEDs electrode sections are comprised of a silver plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the user use the LEDs as soon as possible.

*Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

2. Moisture Proof Package

*When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.

*The moisture proof package is made of an aluminum moisture proof bag with a zipper. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

3. Heat Generation

*Thermal design of the end product is of paramount importance. Please consider the heat generation of the LEDs when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LEDs placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.

*The operating current should be decided after considering the ambient maximum temperature of LEDs.



Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	10/11

4. Static Electricity

*Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

*All devices, equipment and machinery must be properly grounded.

It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

*When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is to find static-damaged LEDs by a light-on or a VF test at a lower current (below 1mA is recommended)

*Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

5. Cleaning

*It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.

*Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

6. Other

*Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.

*The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Solidlite's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).

*User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Solidlite. When defective LEDs are found, the user shall inform Solidlite directly before disassembling or analysis.

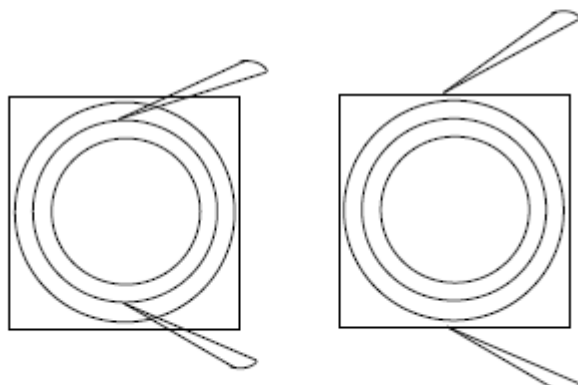
*The formal specifications must be exchanged and signed by both parties before large volume purchased begins.

*The appearance and specifications of the product may be modified for improvement without notice.

Drawing No.	Rev.	Date	Page
AS303GW-ZRM-700mA	A	2025/04/08	11/11

Please follow the guideline to grab LEDs:

- **DO NOT** touch lens with fingers.
- **DO NOT** touch lens with tweezers.
- Use tweezers to grab LED(Shown as below).



Wrong(X)

Correct(O)